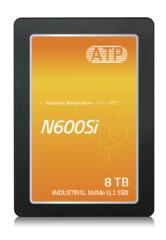


High-Density Thermal U.2 NVMe



Key Features

- Thermal Management Solutions*
- High-Capacity NVMe Drive
- LDPC & RAID Data Recovery
- End-to-End Data Protection
- S.M.A.R.T / TRIM / Global Wear Leveling
- * Customization available on a project basis

D	roduct Name	High-Capacity U.2			
Product Name		U.2			
	Product Line				
	Naming	N600Si			
Flash Type		TLC			
	Density	960 GB to 8 TB			
Deufermen	Sequential Read up to (MB/s)	3,100			
Performance	Sequential Write up to (MB/s)	1,400			
	Interface	PCIe G3x4, NVMe			
Operating Temperature (Tcase)*		-40°C to 85°C			
Relial	pility TBW** (max.)	21,000 TB			
Reliab	ility MTBF @ 25°C	>2,000,000 hours			
Dimens	sions: L x W x H (mm)	100 x 69.85 x 7			

Technologies & Add-On Services	S.M.A.R.T.	TCG Opal 2.0	Advanced Wear Leveling	AutoRefresh	Dynamic Data Refresh	Secure Erase	Industrial Temperature	End-to End Data Protection	Hardware-based Power Loss Protection
Superior	•	•	•	•	•	•	•	•	•

^{*} Case Temperature, the composite temperature as indicated by SMART temperature attributes. ** Under highest Sequential write value. May vary by density, configuration and applications.